



News Release

Unisem (M) Berhad ("Unisem") received Supplier Recognition Award from TriQuint Semiconductor, Inc. (Texas)

Kuala Lumpur, 16 March 2007 – Unisem received the "Supplier Recognition Award" from its valued customer TriQuint Semiconductor, Inc. ("Triquint"), a leading manufacturer of highly integrated RF front-end modules for wireless handsets. This award recognizes rapid turn-around and on time delivery for TGA2723 prototypes during 2006.

Presenting the award to Unisem was Mr John Beall, Package Engineering Team Manager of TriQuint (Texas), "We appreciate the support of the Unisem team for the quick turn around for the samples that enable us to capture the design win," said Mr John Beall.

Receiving the award, Unisem's Senior Vice President/Chief Operating Officer, Mr CS Ho commented, "Unisem will always provide our full support to TriQuint and look forward to expand our business relationship further".

About TriQuint www.triquint.com

TriQuint Semiconductor supplies high-performance modules and components to the world's leading communications companies. Our diverse markets include wireless handsets, base stations, broadband communications and military. We "Connect the digital world to the global network". TriQuint creates standard and custom products using advanced processes that include gallium arsenide (GaAs), surface acoustic wave (SAW) and bulk acoustic wave (BAW) technologies. TriQuint has manufacturing facilities in Oregon, Texas, and Florida, a production plant in Costa Rica, and design centers in North America and Germany. These manufacturing and production facilities are certified to the ISO9001 international quality standard. TriQuint is headquartered at 2300 NE Brookwood Parkway, Hillsboro, Oregon 97124 (USA).

About Unisem www.unisem.com.my

Unisem (M) Berhad, a leading semiconductor packaging and test services company in Malaysia, has its main packaging and testing facilities in Ipoh, Malaysia with additional packaging and testing facilities in Wales, United Kingdom, and in Chengdu, PRC. Unisem offers an integrated suite of packaging and test services for semiconductor companies such as wafer probe, a wide range of leadframe and substrate IC packaging, high-end RF and mix-signal test, tape & reel and drop-shipment services.

UNISEM (M) BERHAD (Company No. 183314-V)

letter box 95, 9th floor, ubn tower, 10 jalan p. ramlee, 50250 kuala lumpur, malaysia
tel : +603 2072 3760 fax : +603 2072 4018 url : www.unisem.com.my